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2014年1月

FCP7N60 / FCPF7N60

N 沟道 SuperFET[®] MOSFET 600 V, 7 A, 600 m Ω

特性

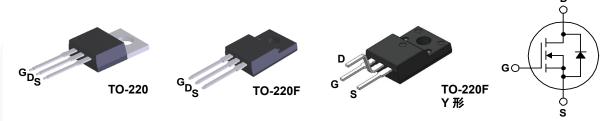
- 650 V @ T_J = 150°C
- 典型值 R_{DS(on)} = 530 mΩ
- 超低栅极电荷 (典型值 Q_q = 23 nC)
- 低有效输出电容 (典型值 C_{oss(eff.)}= 60 pF)
- 100% 经过雪崩测试
- 符合 RoHS 标准

应用

- LCD/LED/PDP 电视
- 太阳能逆变器
- AC-DC 电源

说明

SuperFET[®] MOSFET 是飞兆半导体第一代利用电荷平衡技术实现出色低导通电阻和更低栅极电荷性能的高压超级结(SJ)MOSFET 系列产品。这项技术专用于最小化导通损耗并提供卓越的开关性能、dv/dt 额定值和更高雪崩能量。因此,SuperFET MOSFET 非常适合开关电源应用,如功率因数校正 (PFC)、服务器 / 电信电源、平板电视电源、ATX 电源及工业电源应用。



绝对最大额定值 T_C = 25℃ 除非另有说明。

符号	参数			FCP7N60	FCPF7N60 / FCPF7N60YDTU	单位
V_{DSS}	漏极一源极电压				V	
I _D	漏极电流	- 连续 (T _C = 25°C) - 连续 (T _C = 100°C)		7 4.4	7* 4.4*	A A
I _{DM}	漏极电流	- 脉冲	(注1)	21	21*	Α
V_{GSS}	栅极至源极电压				V	
E _{AS}	单脉冲雪崩能量		(注2)		mJ	
I _{AR}	雪崩电流		(注 1)		Α	
E _{AR}	重复雪崩能量 (注1)		(注1)	8.3		
dv/dt	二极管恢复 dv/dt 峰值		(注3)	4.5		V/ns
P _D	功耗	(T _C = 25°C) - 超过 25°C 时降额		83 0.67	31 0.25	W/°C
T _{J,} T _{STG}	工作和存储温度	工作和存储温度范围		-55 至 +150		
T _L	用于焊接的最高引脚温度,距离外壳 1/8",持续 5 秒			300		

^{*}漏极电流受限于最大结温

热性能

符号	参数	FCP7N60	FCPF7N60 / FCPF7N60YDTU	单位
$R_{\theta JC}$	结至外壳热阻最大值	1.5	4.0	°C/W
$R_{\theta JA}$	结至环境热阻最大值	62.5	62.5	C/VV

封装标识与定购信息

器件编号	顶标	封装	包装方法	卷尺寸	带宽	数量
FCP7N60	FCP7N60	TO220	塑料管	不适用	不适用	50 单元
FCPF7N60	FCPF7N60	TO220F	塑料管	不适用	不适用	50 单元
FCPF7N60YDTU	FCPF7N60	TO-220F (Y形)	塑料管	不适用	不适用	50 单元

否则电气特性 T_C = 25°C 除非另有说明。

符号	参数 工作条件		最小值	典型值	最大值	单位
关断特性	•					
BV _{DSS}	漏极一源极击穿电压	V_{GS} = 0 V, I_{D} = 250 μ A, T_{J} = 25°C	600			V
		V_{GS} = 0 V, I_{D} = 250 μ A, T_{J} = 150°C		650		V
ΔBV _{DSS} / ΔT _J	击穿电压温度系数	I _D = 250 μA,参考 25°C		0.6		V/°C
BV _{DS}	漏源极雪崩击穿电压	V _{GS} = 0 V, I _D = 7 A		700		V
I _{DSS}	零栅极电压漏极电流	V _{DS} = 600 V, V _{GS} = 0 V V _{DS} = 480 V, T _C = 125°C			1 10	μ Α μ Α
I _{GSSF}	栅极 - 体漏电流,正向	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	栅极 - 体漏电流,反向	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
导通特性						
V _{GS(th)}	栅极阈值电压	V _{DS} = V _{GS} , I _D = 250 μA	3.0		5.0	V
R _{DS(on)}	漏极一源极 导通电阻	V _{GS} = 10 V, I _D = 3.5 A	\	0.53	0.6	Ω
9 _{FS}	正向跨导	V _{DS} = 40 V, I _D = 3.5 A		6		S
动态特性						
C _{iss}	输入电容	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		710	920	pF
C _{oss}	输出电容			380	500	pF
C _{rss}	反向传输电容			34		pF
C _{oss}	输出电容	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		22	29	pF
C _{oss(eff.)}	有效输出电容	V_{DS} = 0 V \cong 400 V, V_{GS} = 0 V	/	60		pF
开关特性						
t _{d(on)}	导通延迟时间	$V_{DD} = 300 \text{ V}, I_D = 7 \text{ A},$	/	35	80	ns
t _r	开通上升时间	V_{GS} = 10 V, R_{G} = 25 Ω		55	120	ns
t _{d(off)}	关断延迟时间			75	160	ns
t _f	关断下降时间	(说明 4)		32	75	ns
Q _g	总栅极电荷	V _{DS} = 480 V, I _D = 7 A,		23	30	nC
Q _{gs}	栅极至源极电荷	V _{GS} = 10 V		4.2	5.5	nC
Q _{gd}	栅极至漏极电荷	(说明 4)		11.5		nC
漏极 - 源极	二极管特性和最大额定值				7.1	21
I _S	漏极 - 源极二极管最大正向连续电流				7	Α
I _{SM}	漏极 - 源极二极管最大正向脉冲电流				21	Α
V_{SD}	漏极 - 源极二极管正向电压	V _{GS} = 0 V, I _S = 7 A		-	1.4	V
t _{rr}	反向恢复时间	V _{GS} = 0 V, I _S = 7 A,		360		ns
Q _{rr}	反向恢复电荷	dl _F /dt =100 A/μs		4.5		μС

- 1. 重复额定值: 脉冲宽度受限于最大结温。
 2. $I_{AS} = 3.5 \text{ A}$, $V_{DD} = 50 \text{ V}$, $R_{G} = 25 \Omega$, 启动 $T_{J} = 25 ^{\circ}\text{C}$ 。
 3. $I_{SD} \le 7 \text{ A}$, $di/dt \le 200 \text{ A}/\mu\text{s}$, $V_{DD} \le \text{BV}_{DSS}$, 启动 $T_{J} = 25 ^{\circ}\text{C}$ 。
- 4. 本质上独立于工作温度的典型特性。

典型性能特征

图 1. 导通区域特性

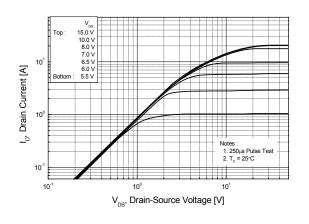


图 2. 传输特性

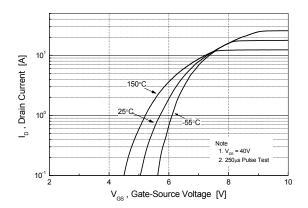


图 3. 导通电阻变化与漏极电流和栅极电压

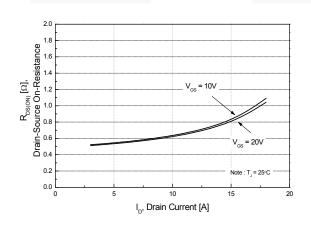


图 4. 体二极管正向电压变化与源极电流和温度的 关系

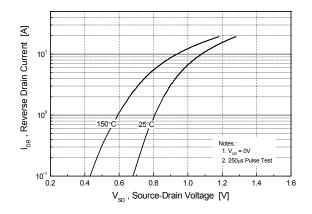


图 5. 电容特性

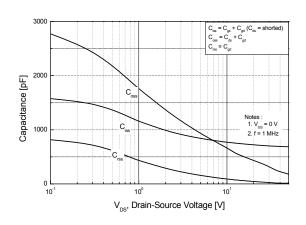
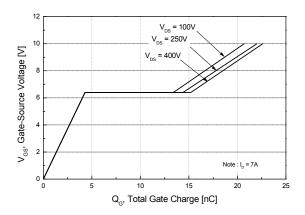


图 6. 栅极电荷



典型性能特征(接上页)

图 7. 击穿电压变化与温度

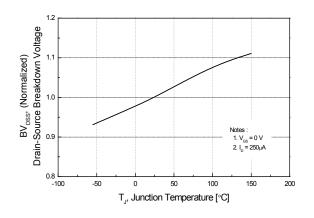


图 8. 导通电阻变化与温度

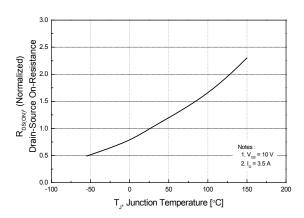


图 9-1. 用于 FCP7N60 最大安全工作区

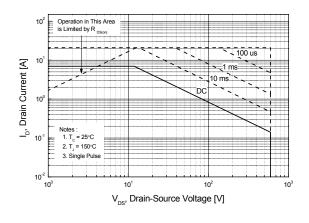


图 9-2. 用于 FCPF7N60 最大安全工作区

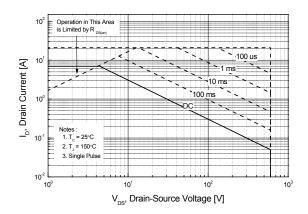
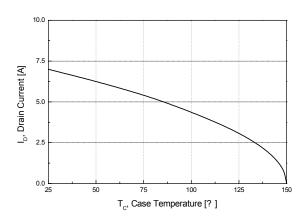


图 10. 最大漏极电流与壳体温度



典型性能特征(接上页)

图 11-1. FCP7N60 的瞬态热响应曲线

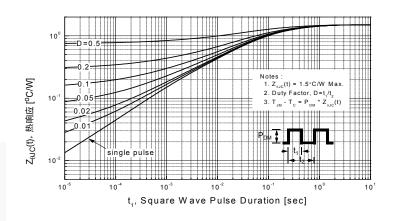
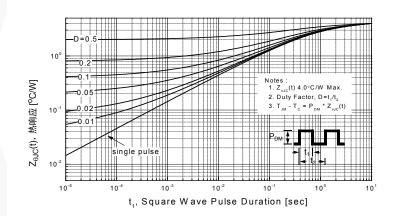


图 11-2. FCPF7N60 的瞬态热响应曲线



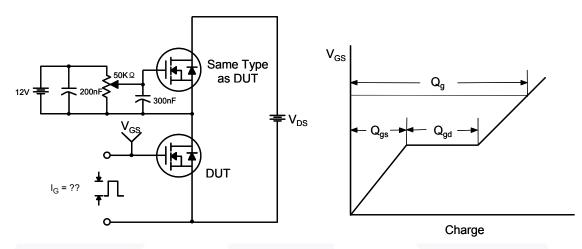


图 12. 栅极电荷测试电路与波形

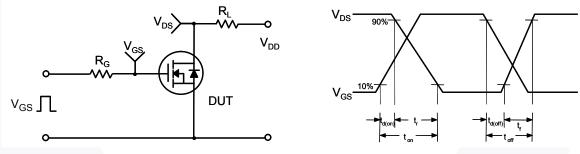


图 13. 阻性开关测试电路与波形

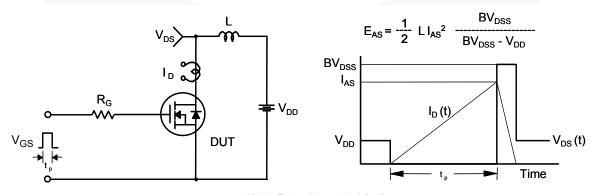


图 14. 非箝位感性开关测试电路与波形

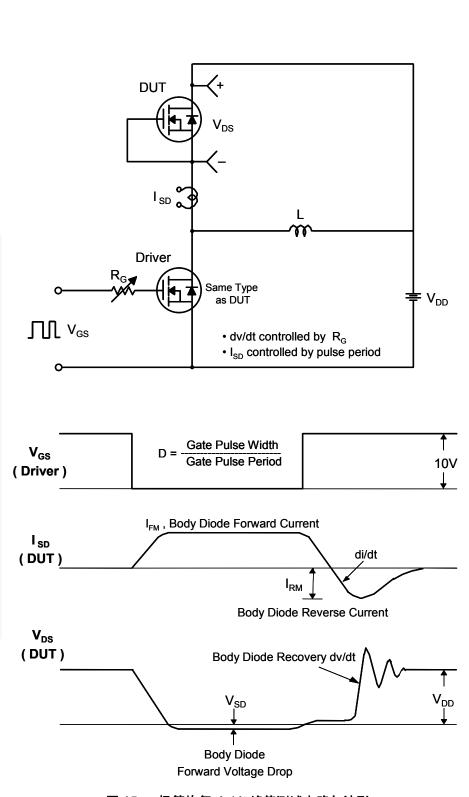
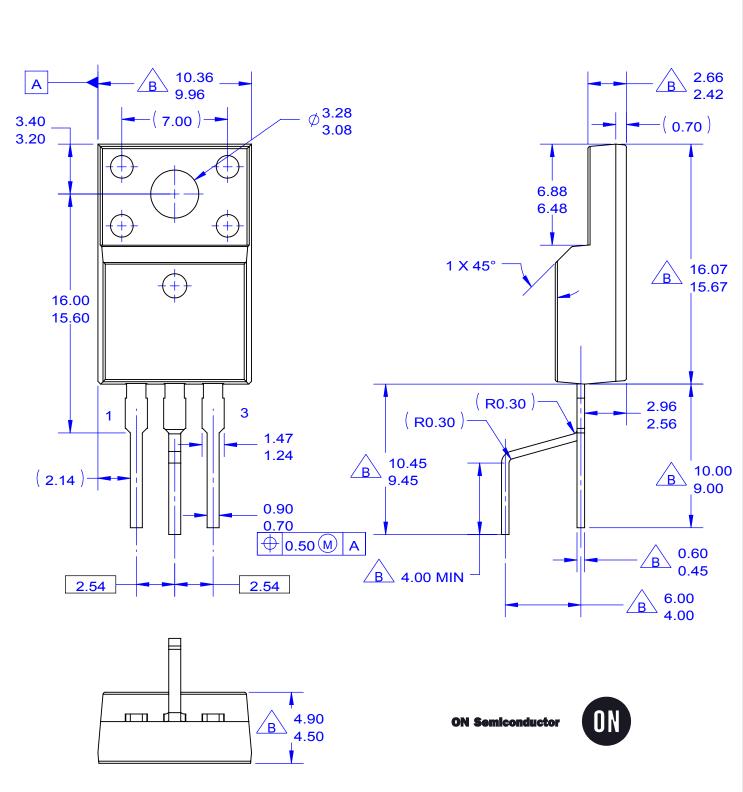


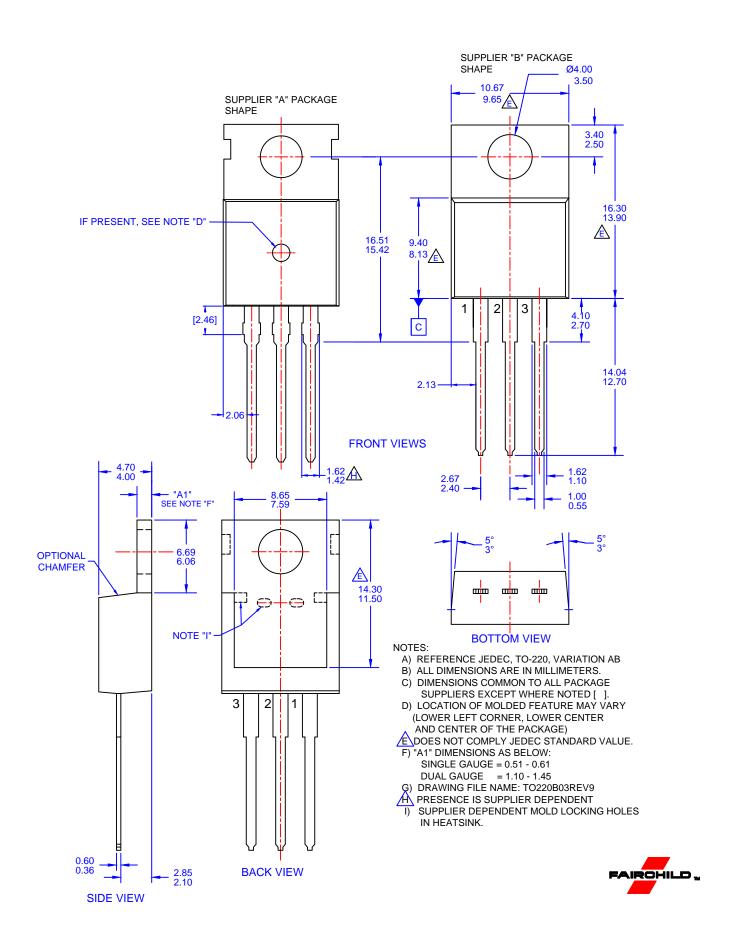
图 15. 二极管恢复 dv/dt 峰值测试电路与波形

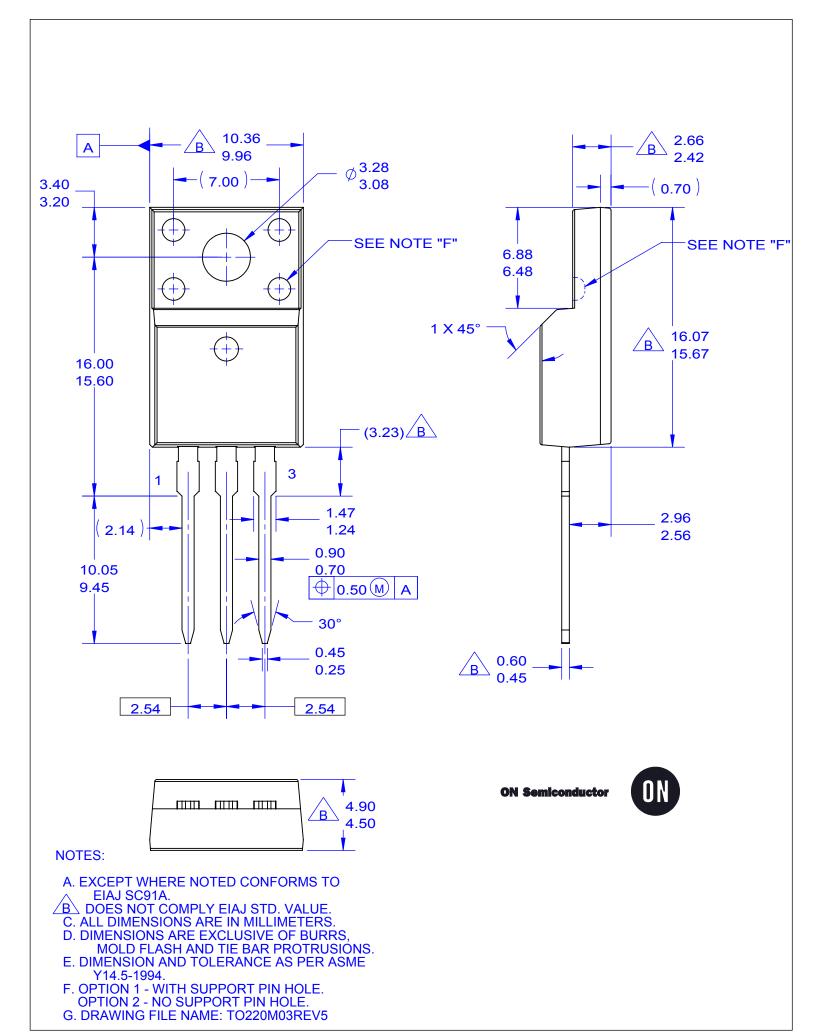


NOTES:

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